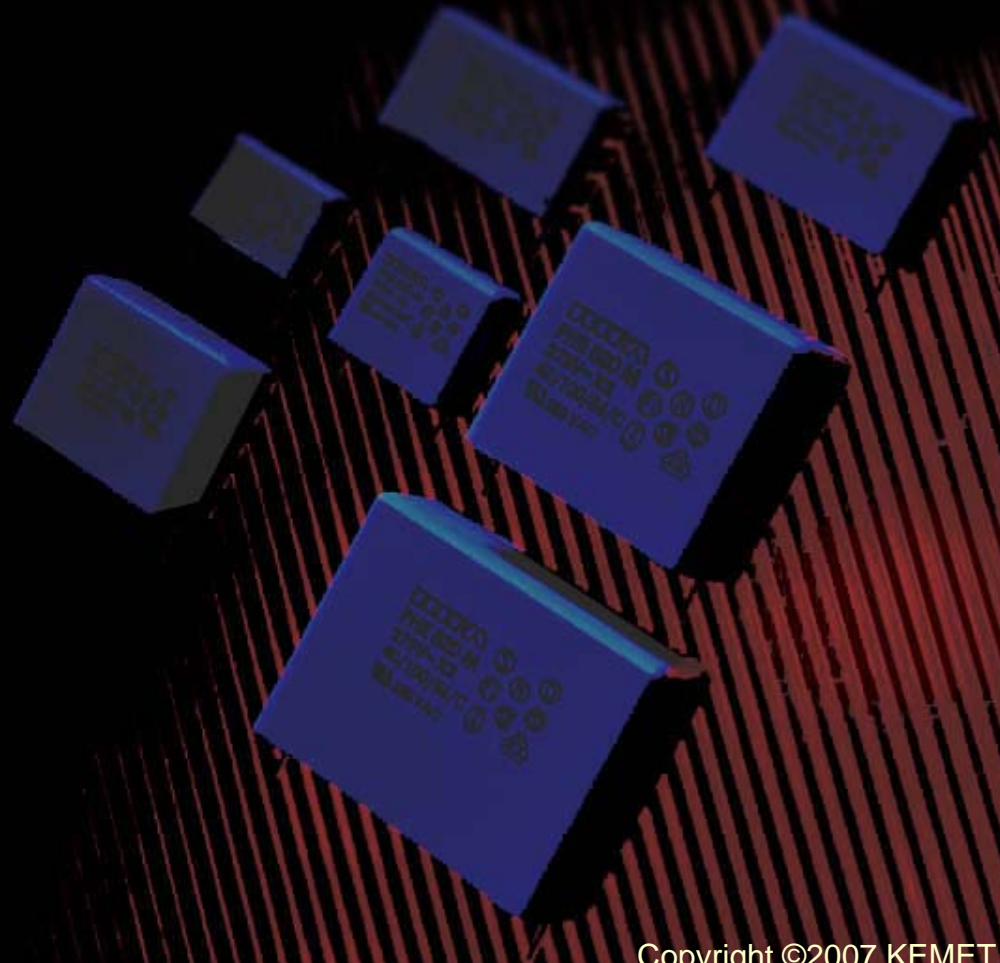
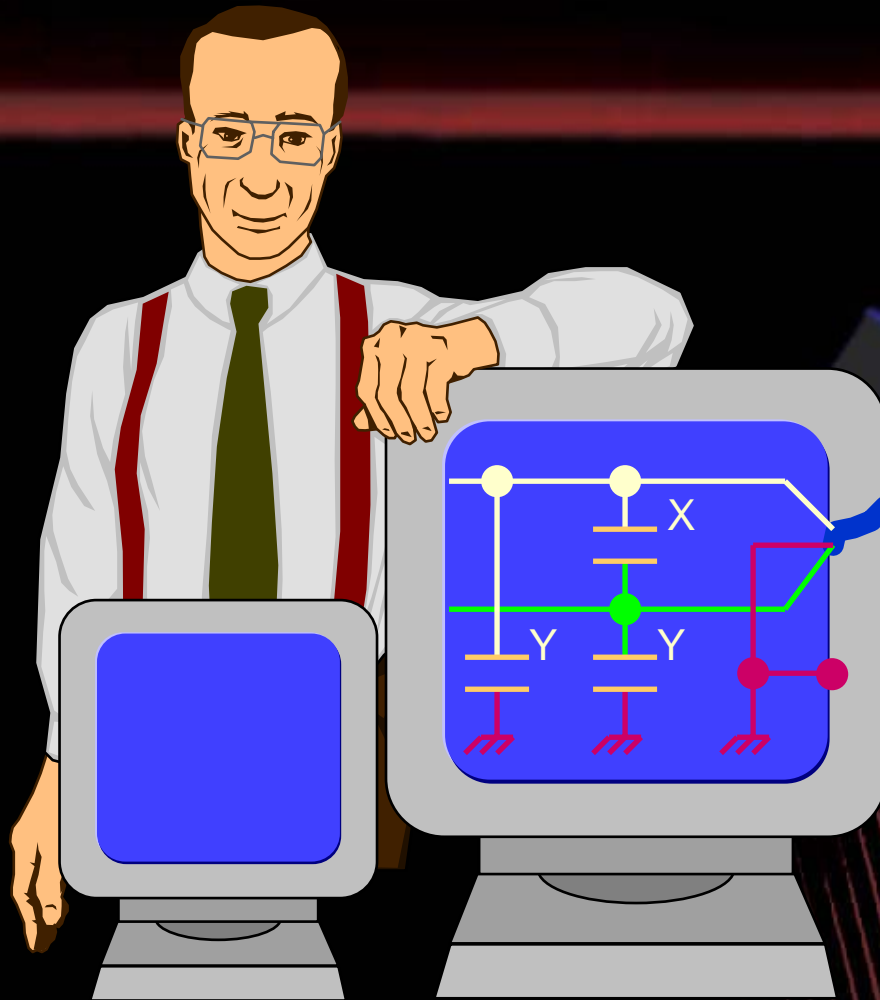


X and Y Capacitors



EMI Capacitors on the AC Line



X capacitors are across the line. If they short-circuit, the risk is fire.

Y capacitors are from line to chassis. If they short-circuit, the risk is a shock to the user.

Because of the risks, X and Y capacitors are safety agency tested.

Self-healing

- Metallized film capacitors can repair themselves after a voltage spike.

Breakdown occurs after surge.



Thin metallization heats up and melts.



Area around breakdown is isolated. No short circuit!



Self-healing

- Metallized film capacitors can repair themselves after a voltage spike.
- Ceramic caps cannot. Their failure mode can be a short circuit, with risk of shock in the case of a Y capacitor.

Breakdown occurs after surge.



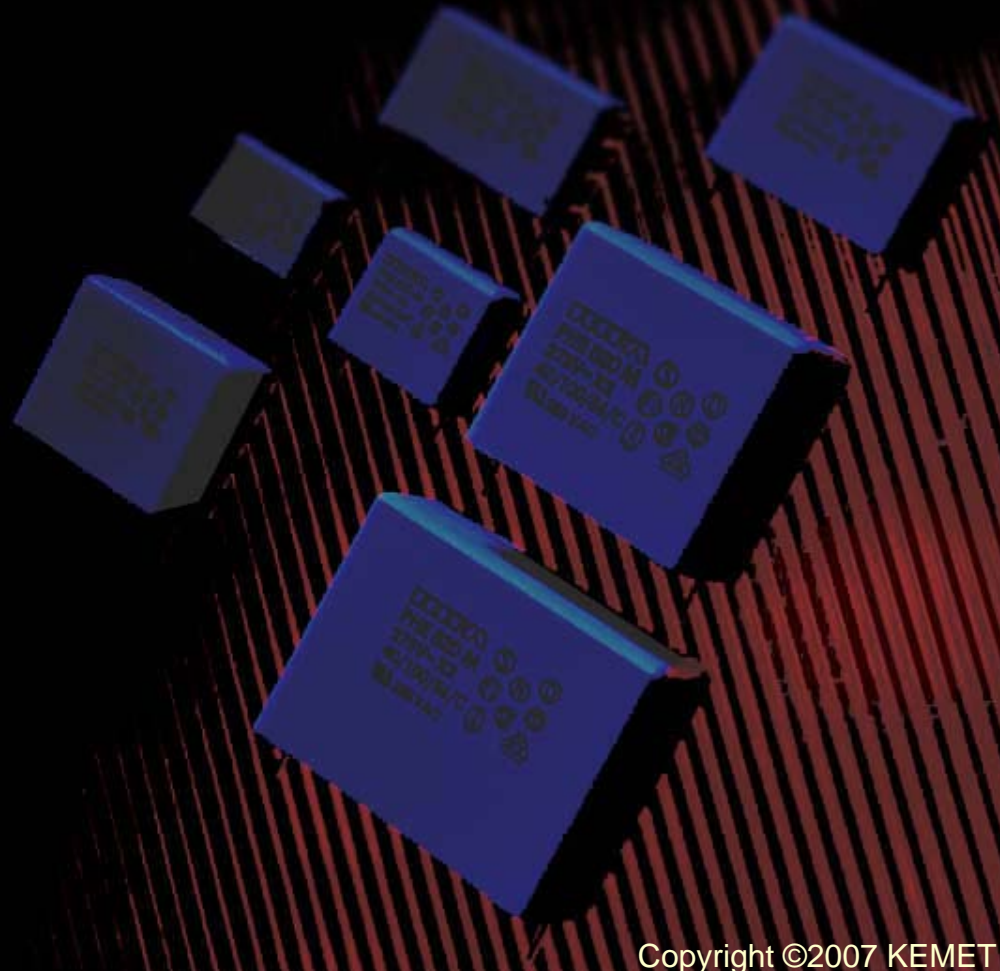
Thin metallization heats up and melts.



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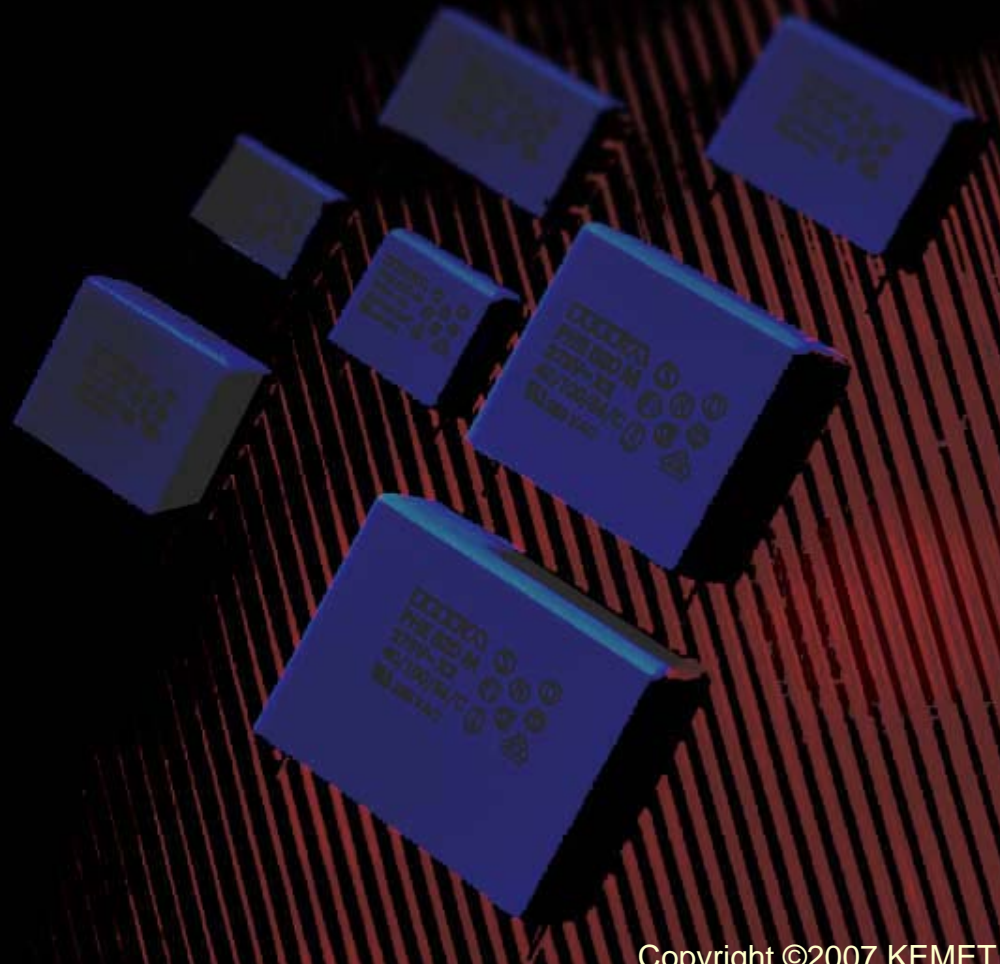


X Capacitors



X2 Capacitor PHE840M

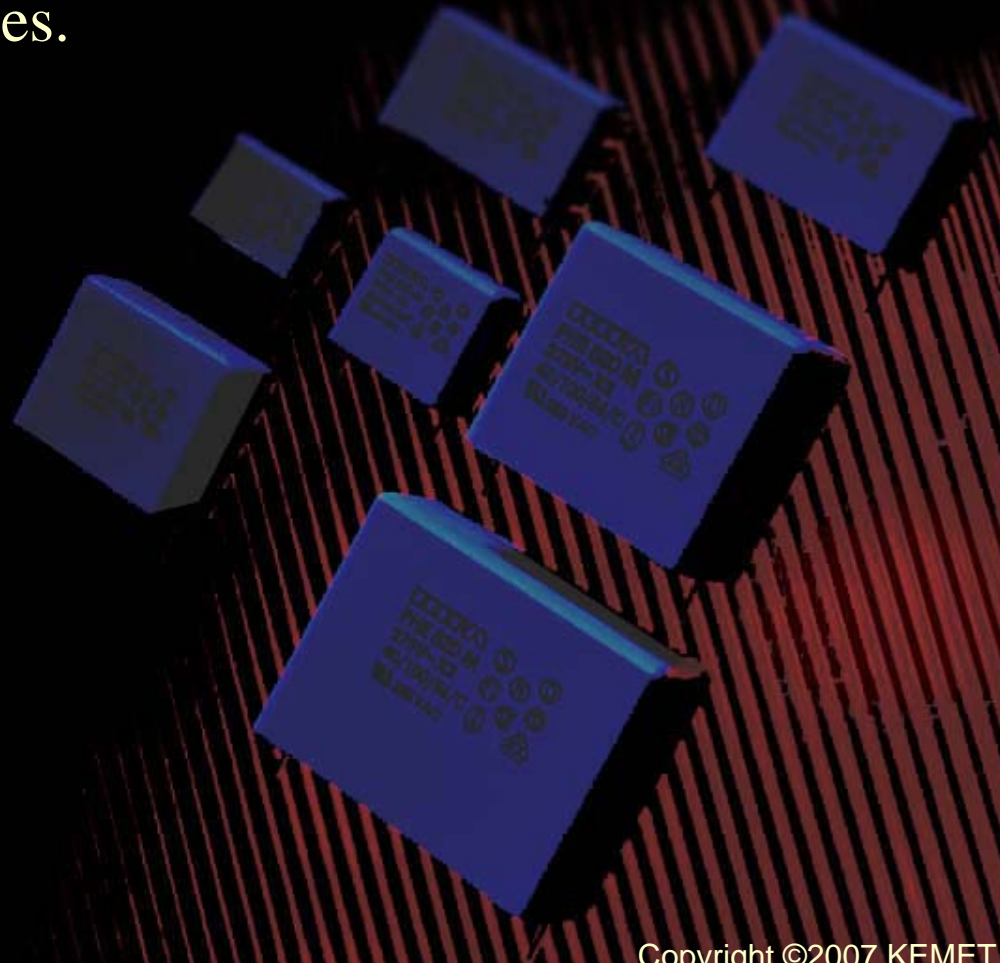
Benefits for the designer



X2 Capacitor PHE840M

Benefits for the designer

- Lower prices, smaller sizes.



X2 Capacitor PHE840M

Benefits for the designer

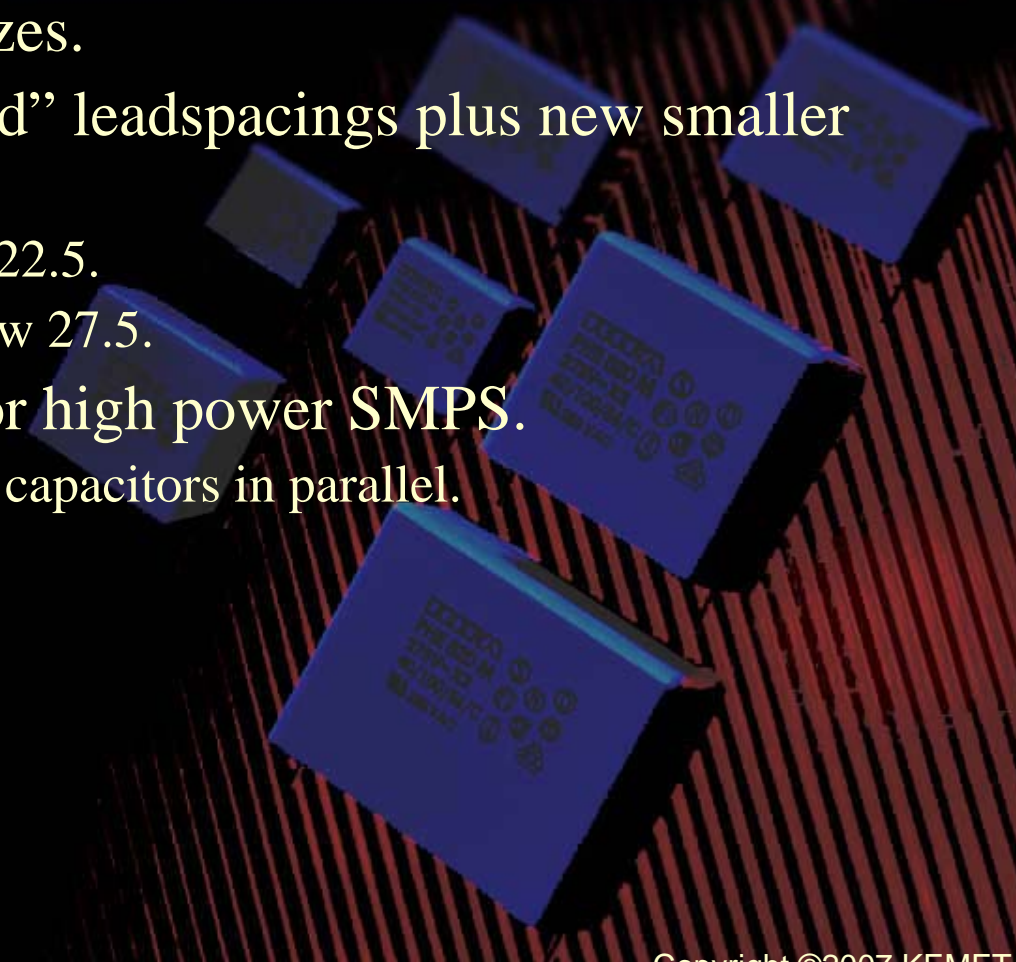
- Lower prices, smaller sizes.
- Many values in “standard” leadspacings plus new smaller alternates.
 - 1 μ F in 27.5mm and new 22.5.
 - 2.2 μ F in 37.5mm and new 27.5.



X2 Capacitor PHE840M

Benefits for the designer

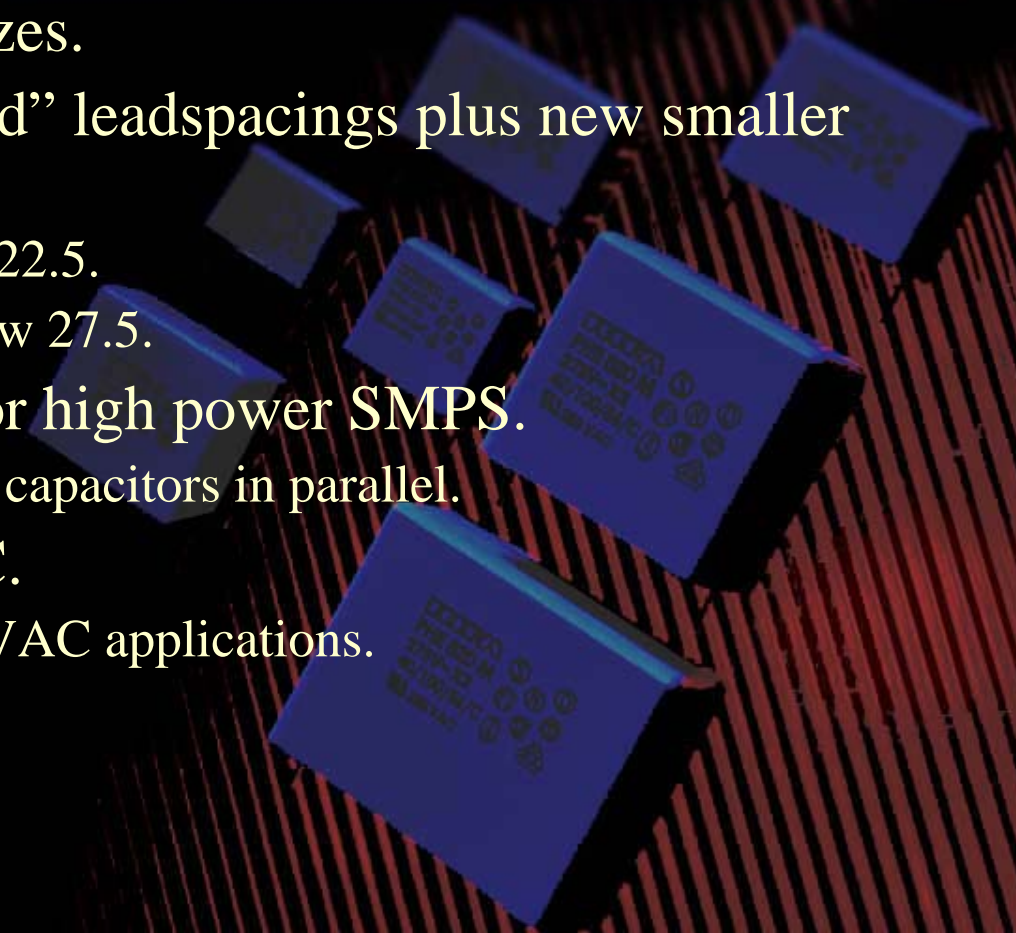
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 - Eases design-ins for 277VAC applications.



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- Max. C-value is 10 μ F for high power SMPS.
 - Eliminates the need for 2 capacitors in parallel.
- UL approval at 280VAC.
 - Eases design-ins for 277VAC applications.
- Low loss polypropylene design for high frequency applications. (Polyester caps can heat up too much.)
 - High frequency motor drives, aircraft power (400Hz).

A Product for Every Voltage

X caps for industrial applications

AC voltage

275/280

300

330

440/480

600 & up

Film

PHE840M

PHE840E

PHE841

PHE844

PHE845

Paper

PME271M

PME271E

PME278

PME264

Use one capacitor of the correct voltage instead of two low-voltage parts in series.

Y Capacitor Comparison

Ceramic

Metallized paper & film

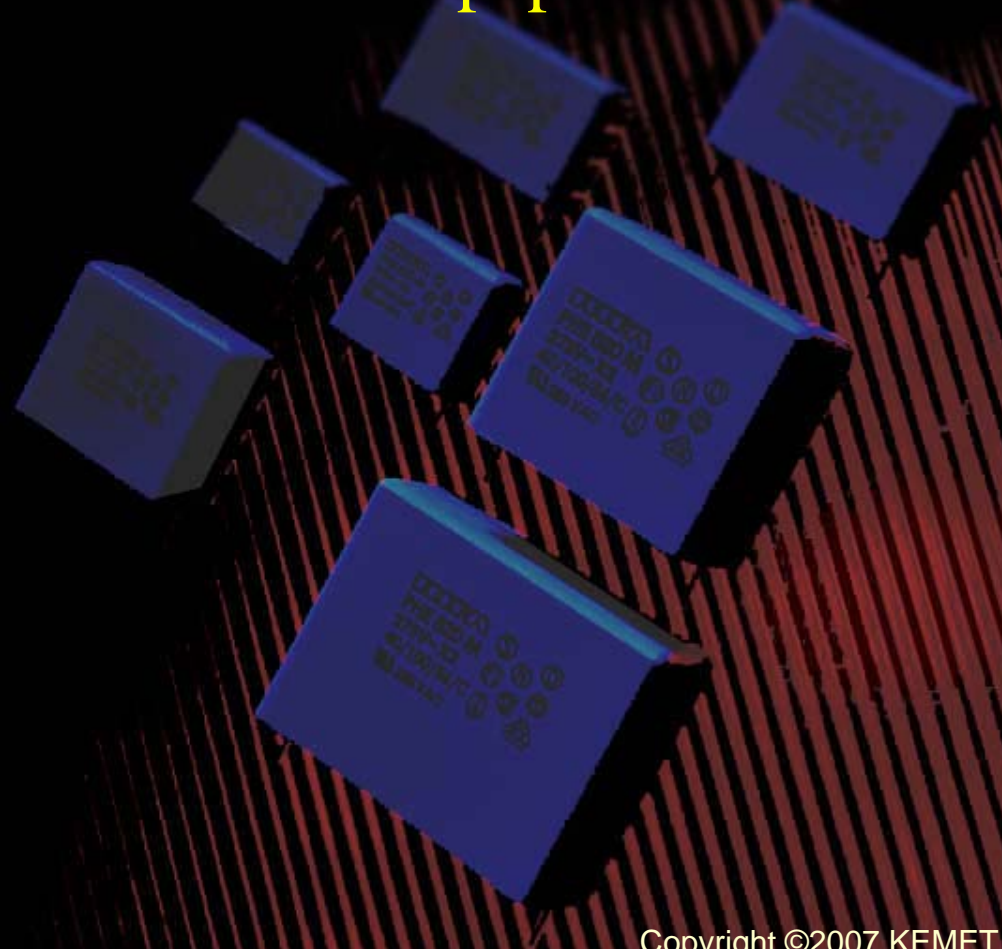


Y Capacitor Comparison

Ceramic

Less expensive.

Metallized paper & film



Y Capacitor Comparison

Ceramic

Less expensive.

Unstable over time and temperature.

Metallized paper & film

Stable.



Y Capacitor Comparison

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Less expensive.

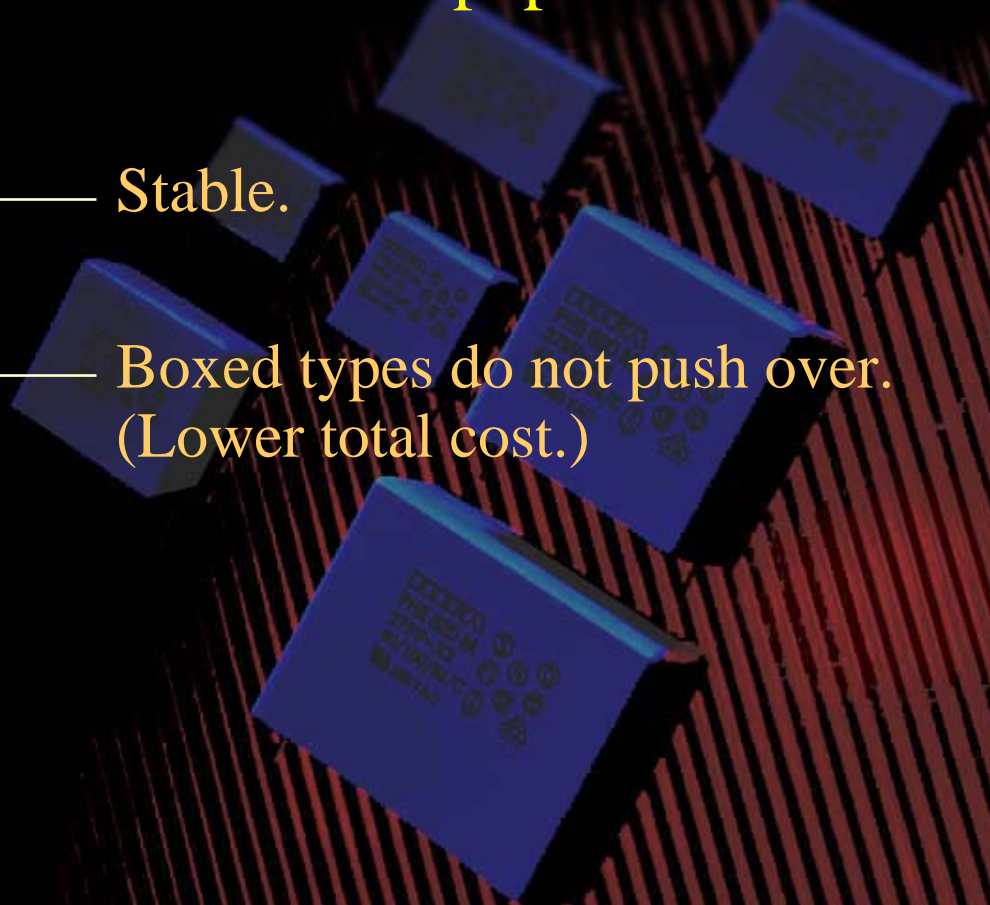
Unstable over time and temperature. _____

Pushes over (may require additional insulation). _____

Metallized paper & film

Stable.

Boxed types do not push over. (Lower total cost.)



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Unstable over time and temperature. _____

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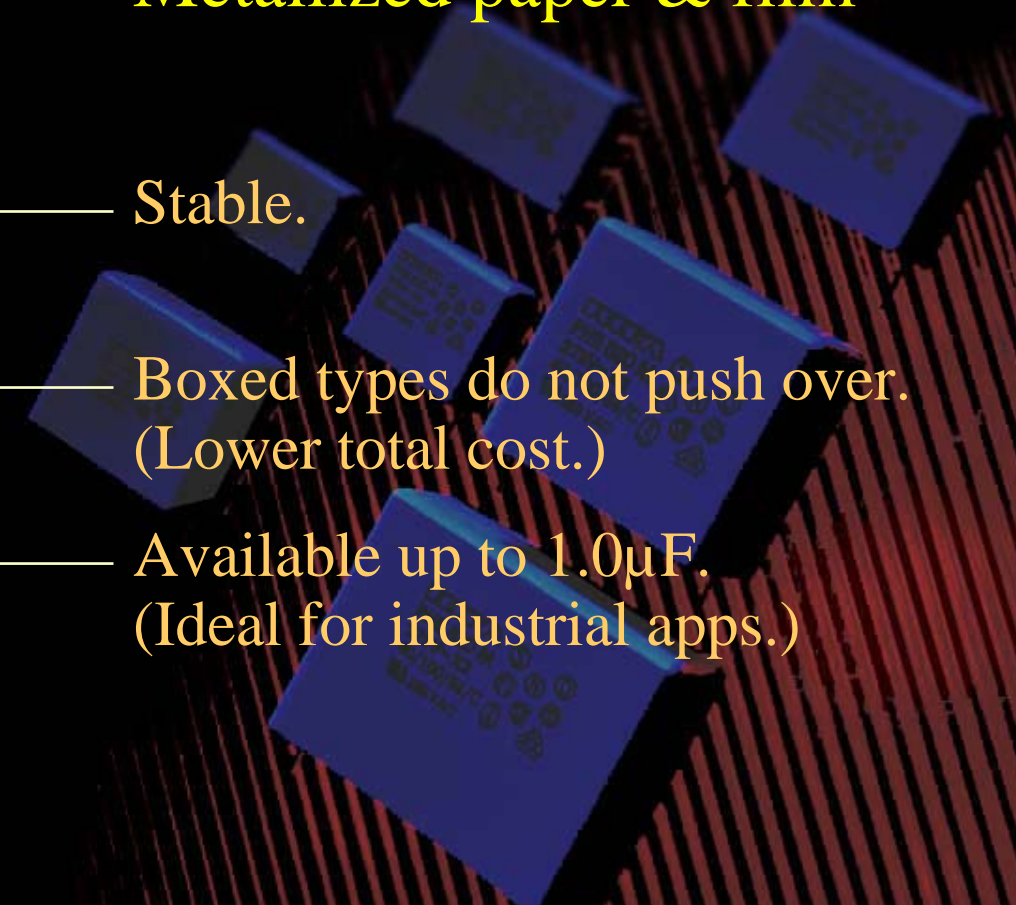
Maximum capacitance available is $\sim 0.022\mu\text{F}$. _____

Metallized paper & film

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Available up to $1.0\mu\text{F}$. (Ideal for industrial apps.)



Y Capacitor Comparison

Ceramic

Less expensive.

Unstable over time and temperature.

Pushes over (may require additional insulation).

Maximum capacitance available is $\sim 0.022\mu\text{F}$.

Failure mode tends toward short circuit.

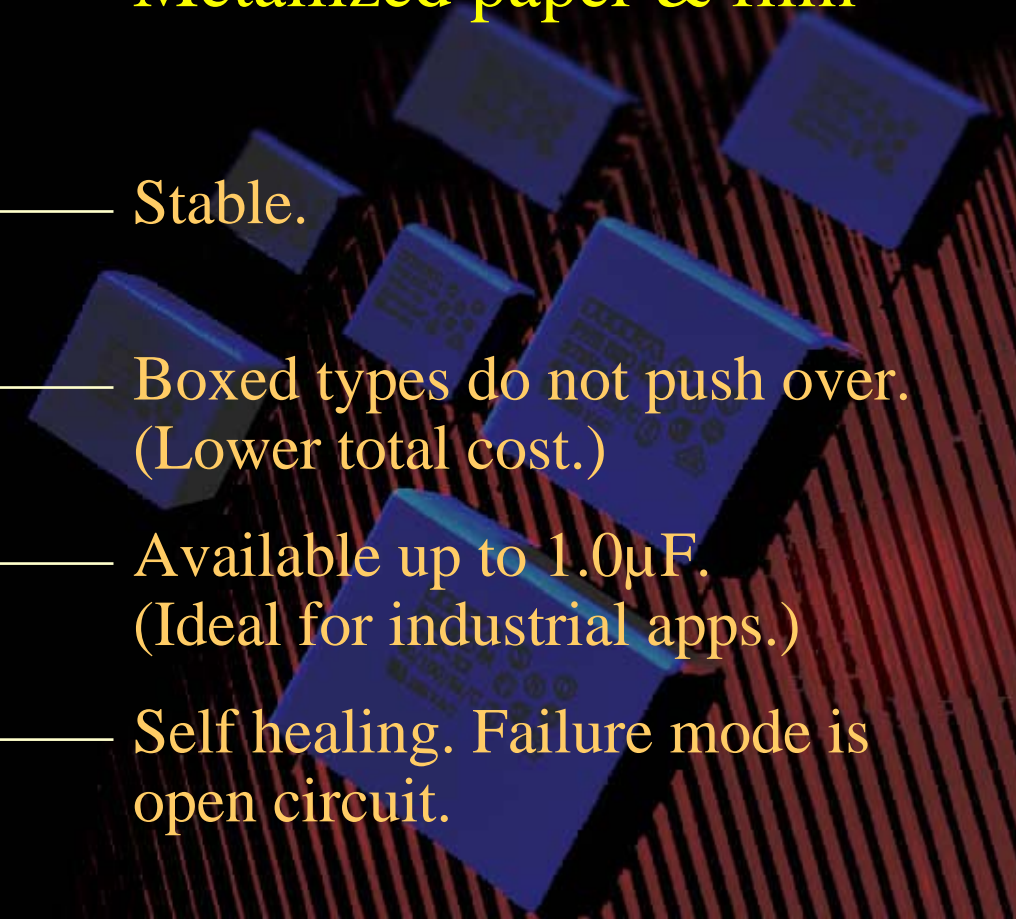
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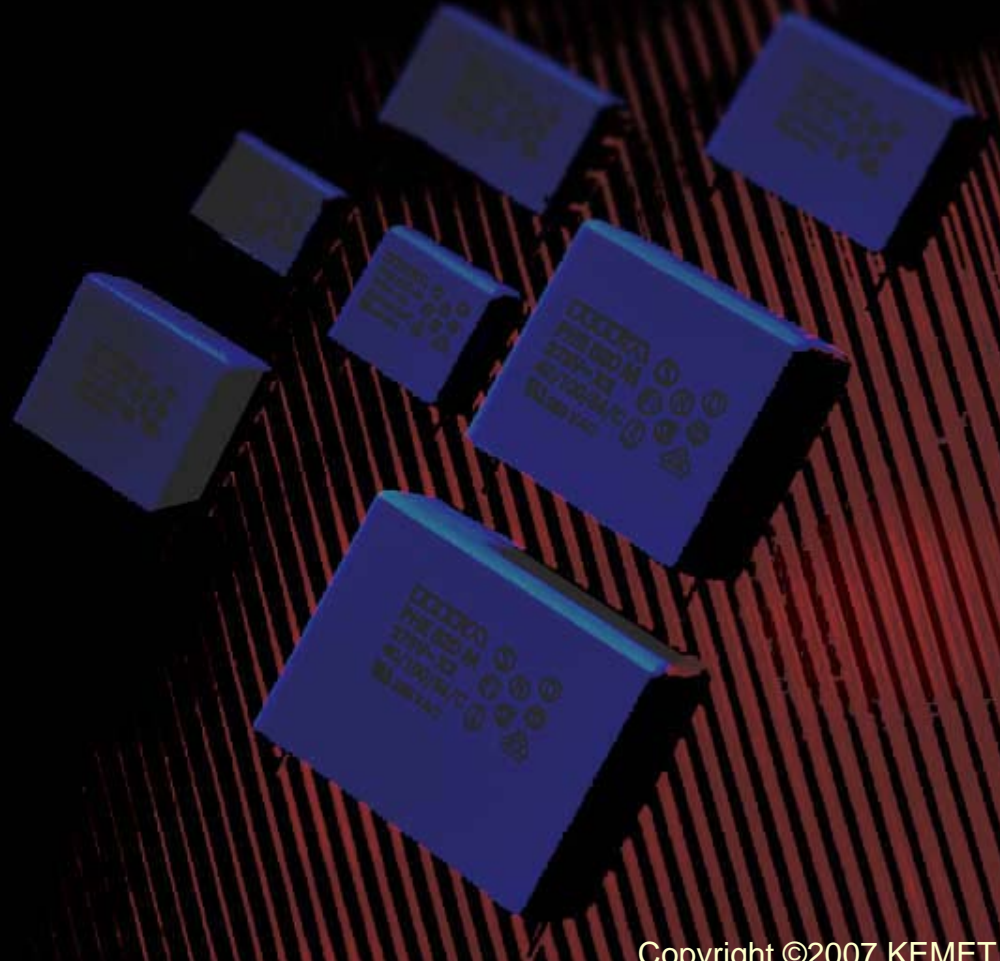
Self healing. Failure mode is open circuit.





New film Y cap PHE850

Alternative to ceramics





New film Y cap PHE850

Alternative to ceramics

- Metallized, self-healing construction.
 - Safer failure mode at near-ceramic prices.

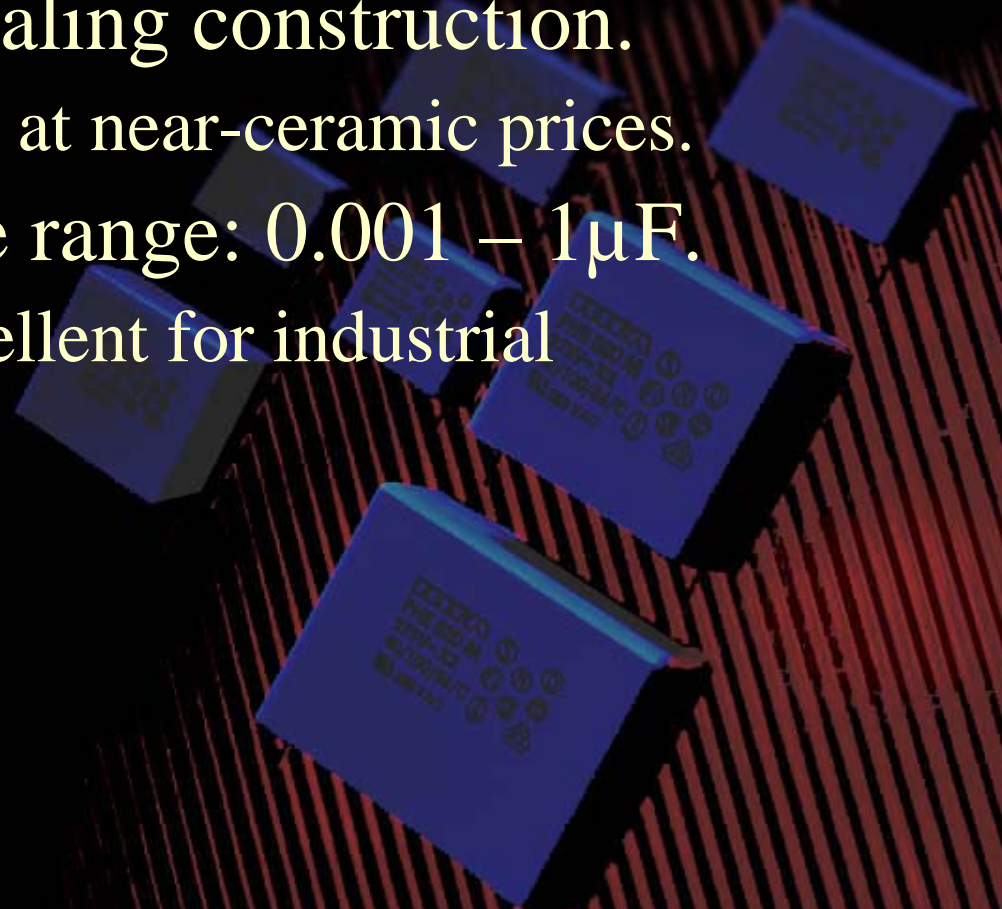




New film Y cap PHE850

Alternative to ceramics

- Metallized, self-healing construction.
 - Safer failure mode at near-ceramic prices.
- Very wide C-value range: 0.001 – 1 μ F.
 - Higher values excellent for industrial applications.

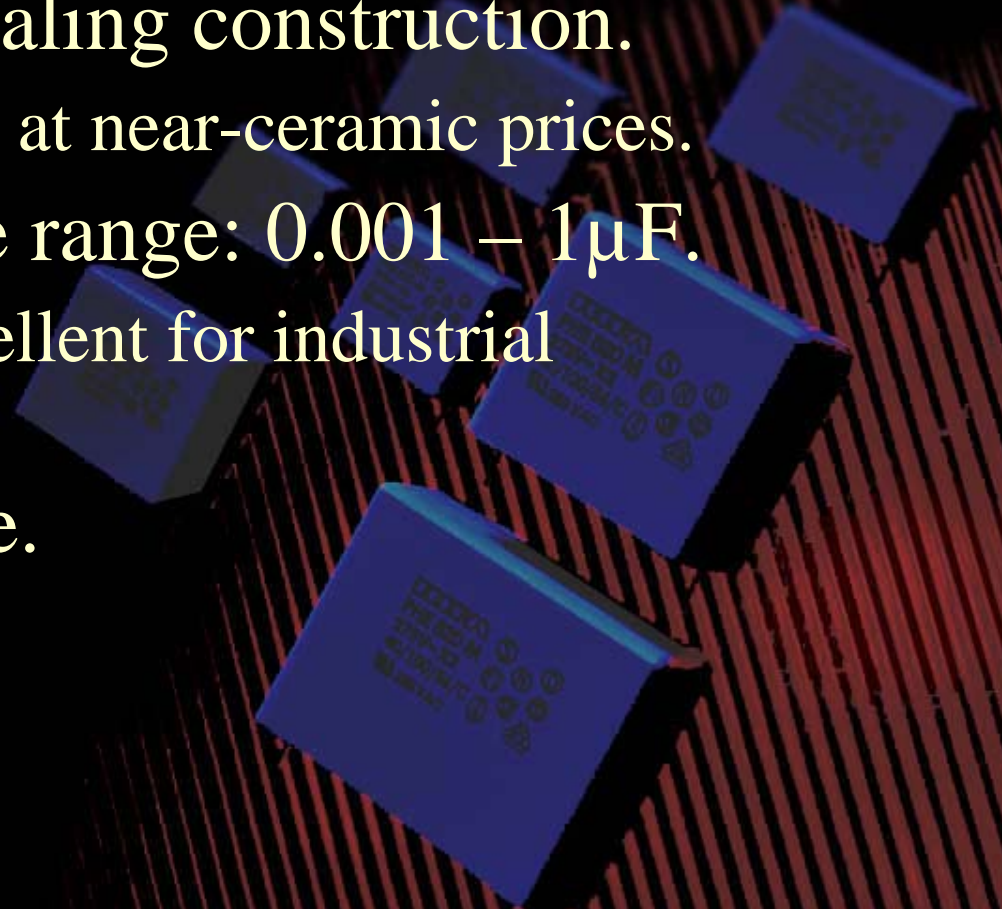




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- Small physical size.





New film Y cap PHE850

Alternative to ceramics

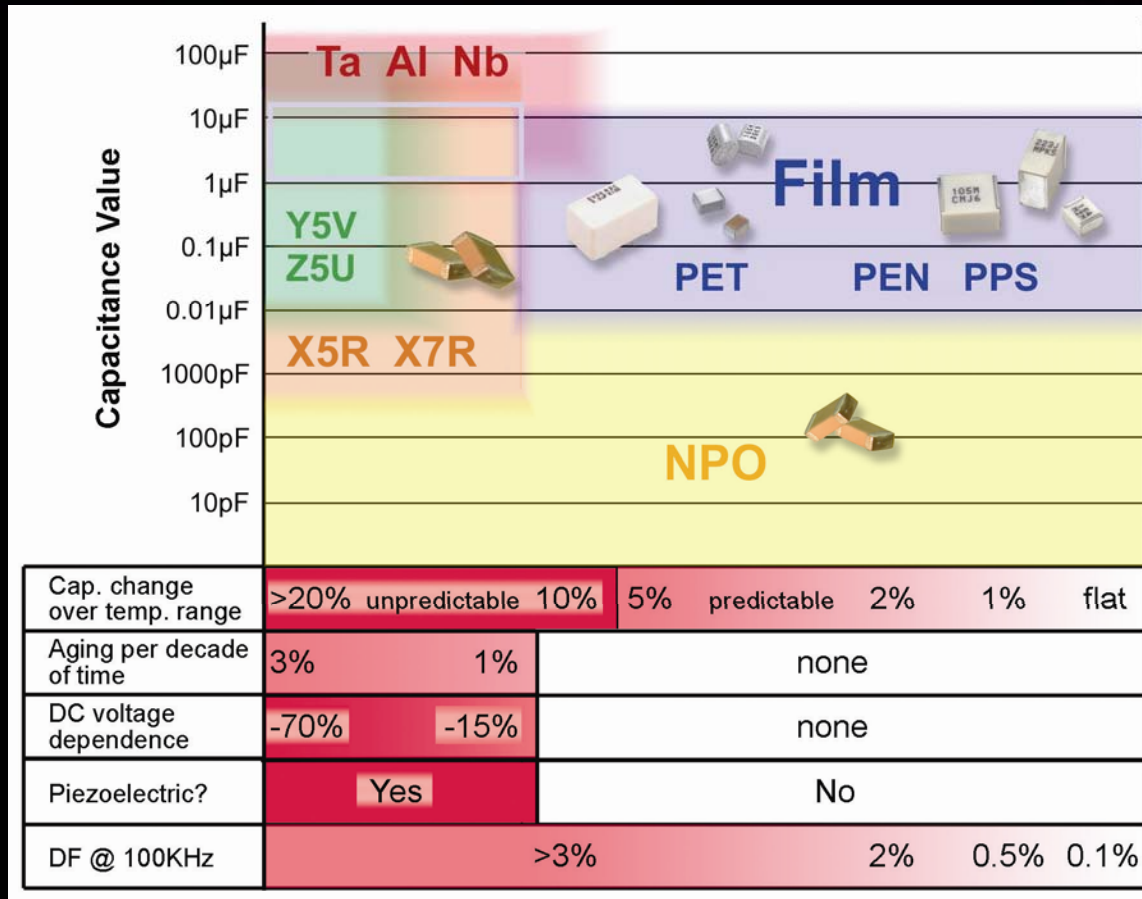
- Metallized, self-healing construction.
 - Safer failure mode at near-ceramic prices.
- Very wide C-value range: 0.001 – 1 μ F.
 - Higher values excellent for industrial applications.
- Small physical size.
- Does not push over.
 - Can lower total cost to use.



SMD Film Capacitors

Focusing the sales effort
for maximum results

SMD Application Chart

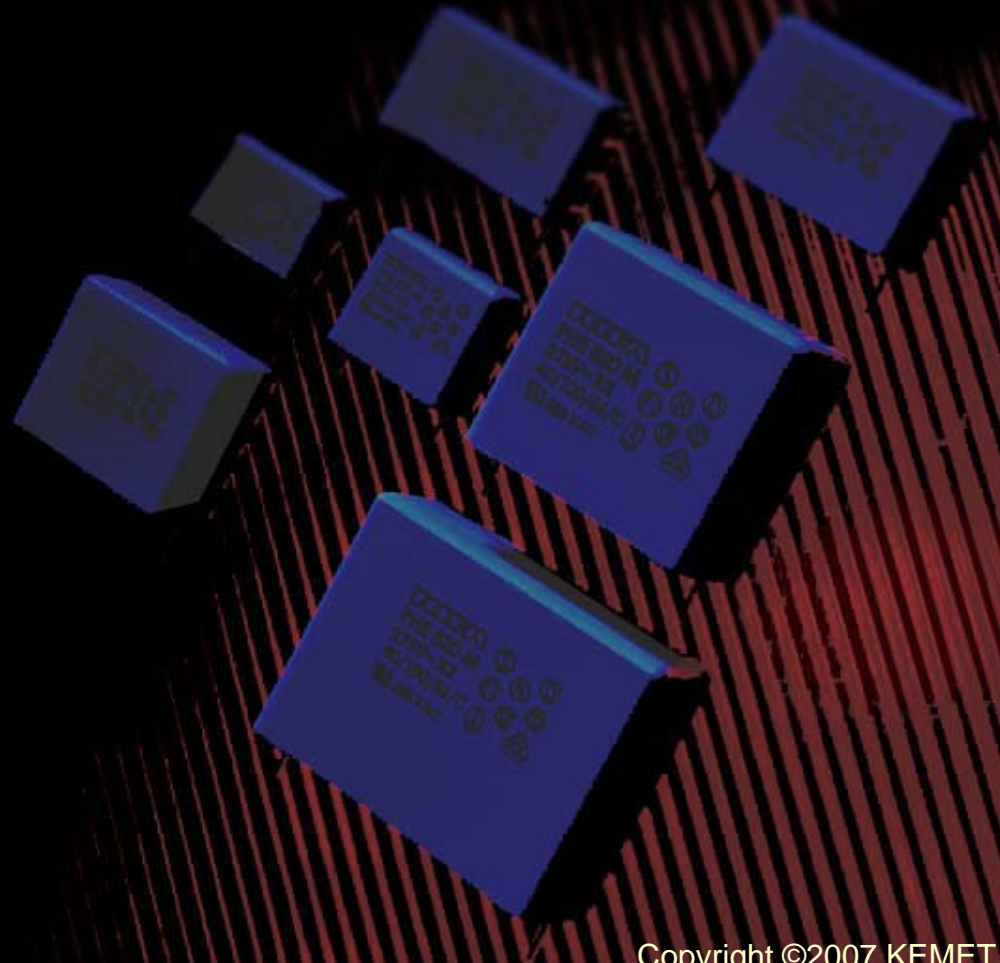


Solder Withstand is a Critical Factor

- Economical Pb-free solders require higher soldering temperatures. Also small parts heat more than large ones.
- More care is needed in choosing an SMD film cap. Cost vs. higher allowed temperature.
- The catalog is a good general guideline of the worst case, but some sizes handle more heat than others.

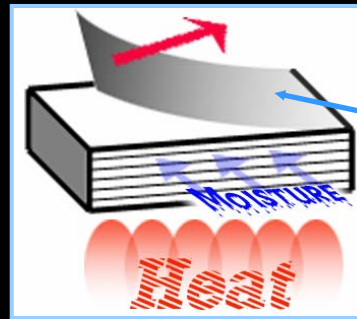
If unsure get the customer's solder profile.

Comparing Naked and Encapsulated



Delamination in Naked Stacked SMD Capacitors

Naked stacked construction



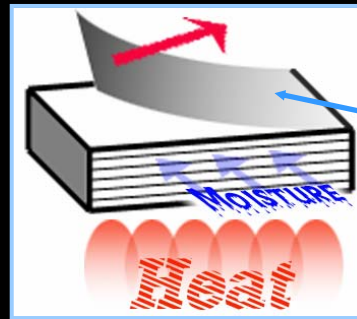
Potential delamination of stack with heat and moisture. More a potential problem in large sizes.

“In case of high humidity storage and short cycle reflow soldering profiles, it is recommended that the capacitors be pre-conditioned in an 85°C oven for a minimum of 12 hours prior to reflow soldering to minimize any effects caused by the rapid vaporization of the moisture.”

Source: ITW Paktron Film Capacitor Catalog

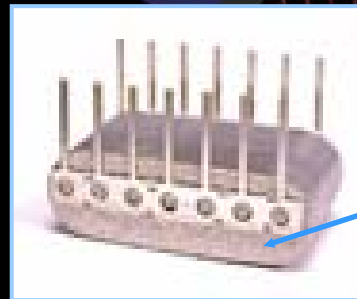
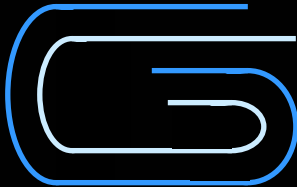
Wound & Encapsulated Capacitors Do Not Delaminate

Naked stacked construction



Potential delamination of stack with heat and moisture. More a potential problem in large sizes.

Wound construction



Winding holds itself together. No delamination.

SMD Film Technologies

**Naked stacked
(Arco LDE, LDB)**

**Encapsulated
(MMC, GMC, SMC)**



SMD Film Technologies

Naked stacked (Arco LDE, LDB)

- **Good solder withstand.**
- **Acceptable environmental performance in many applications.**
- **Smaller physical size, especially in low voltages.**
- **Potentially lower cost in small sizes.**
- **Potential delamination in larger sizes.**

Encapsulated (MMC, GMC, SMC)



SMD Film Technologies

Naked stacked (Arco LDE, LDB)

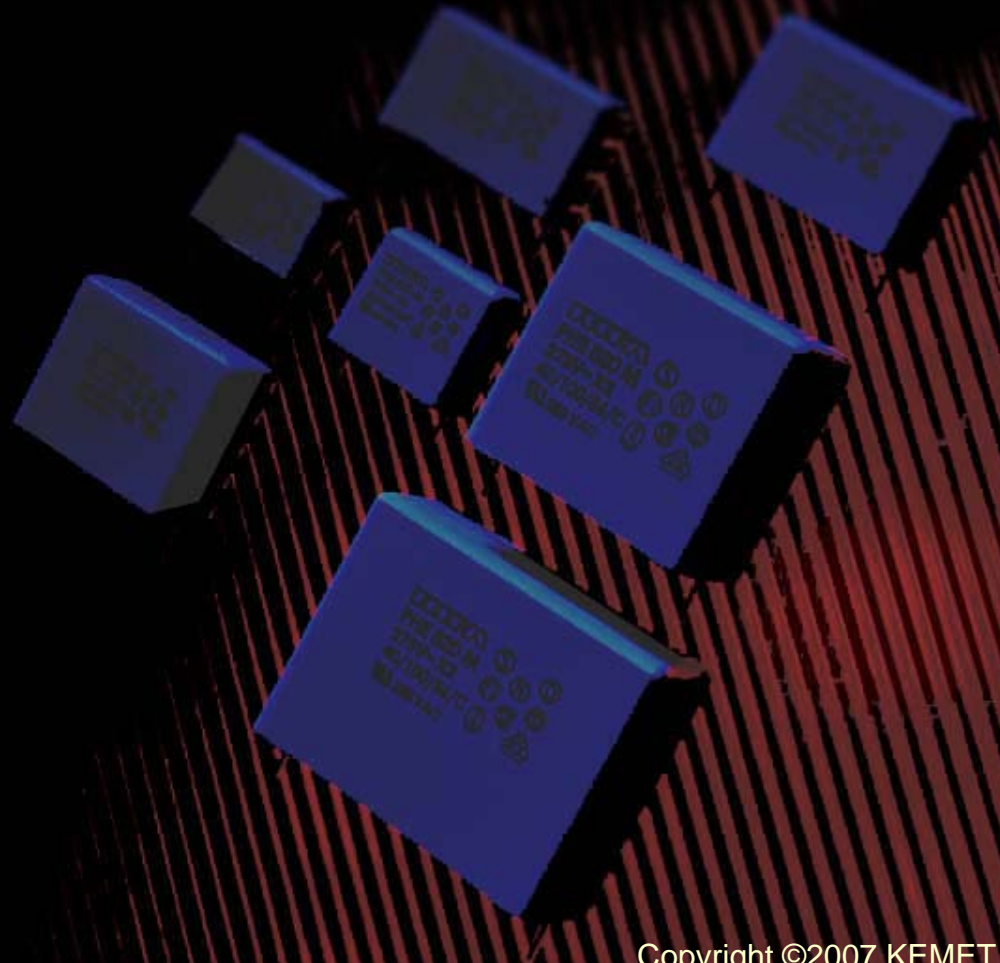
- **Good solder withstand.**
- **Acceptable environmental performance in many applications.**
- **Smaller physical size, especially in low voltages.**
- **Potentially lower cost in small sizes.**
- **Potential delamination in larger sizes.**

Encapsulated (MMC, GMC, SMC)

- **Better solder withstand.**
- **Better environmental performance, resistance to moisture / chemicals.**
- **Larger physical size.**
(Vertical mounting can help!)
- **Potentially higher cost in small sizes.**
- **Will not delaminate.**



*A Focused Sales Effort
Will Yield Results!*

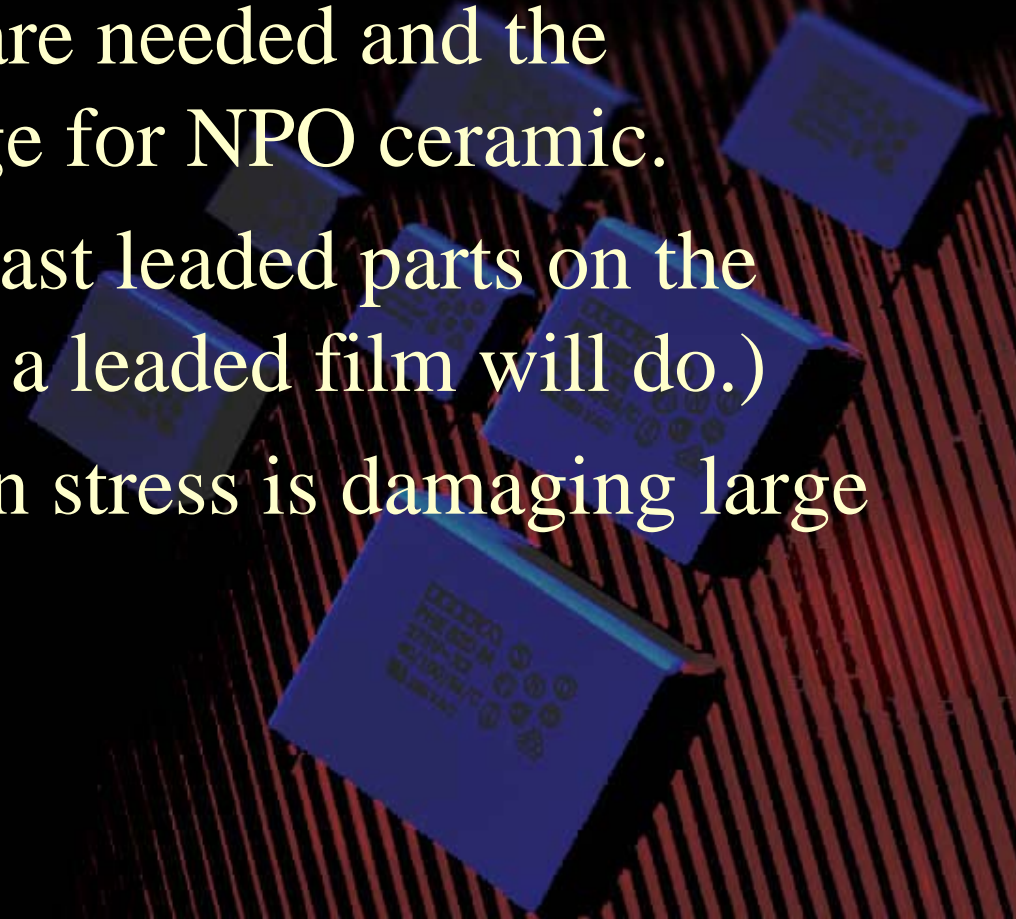




Film SMD will be used when...



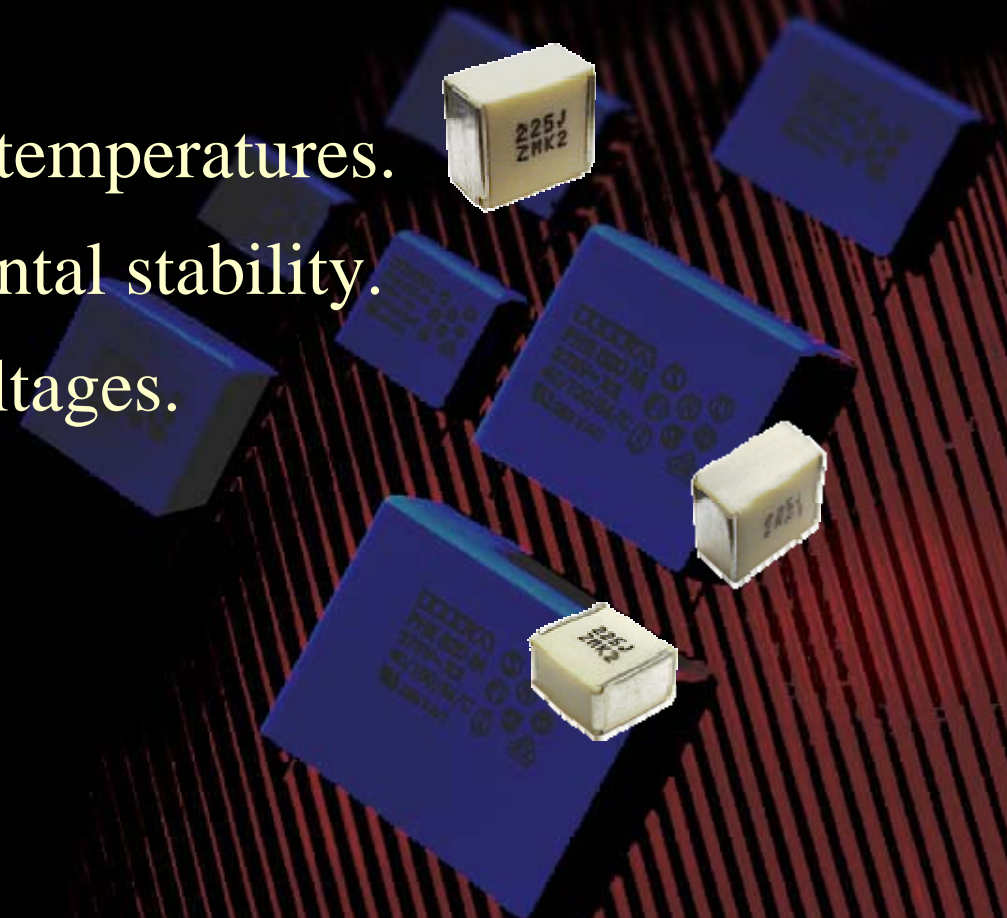
- Stable properties are needed and the C-value is too large for NPO ceramic.
- The films are the last leaded parts on the board. (Otherwise a leaded film will do.)
- Thermal expansion stress is damaging large ceramics.



There is a place for naked and encapsulated:

Encapsulated:

- For higher soldering temperatures.
- For better environmental stability.
- Higher C-values / voltages.



There is a place for naked and encapsulated:

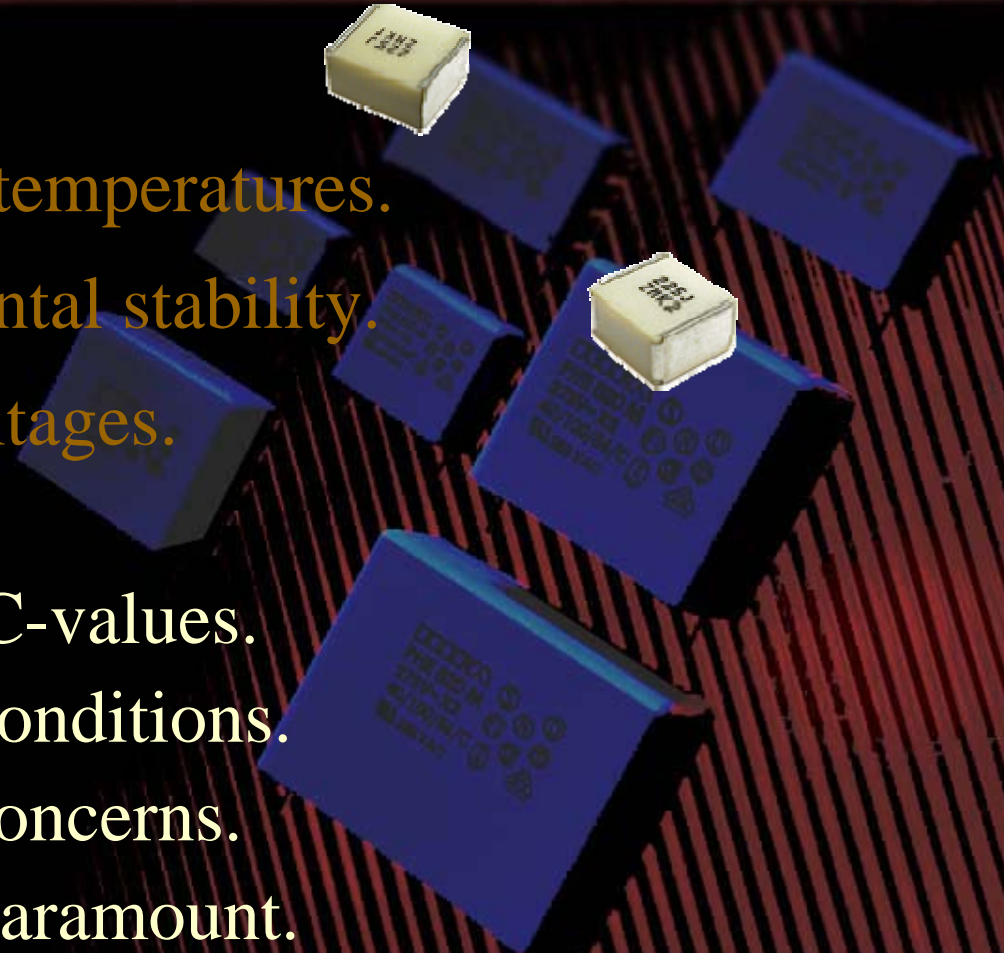


Encapsulated:

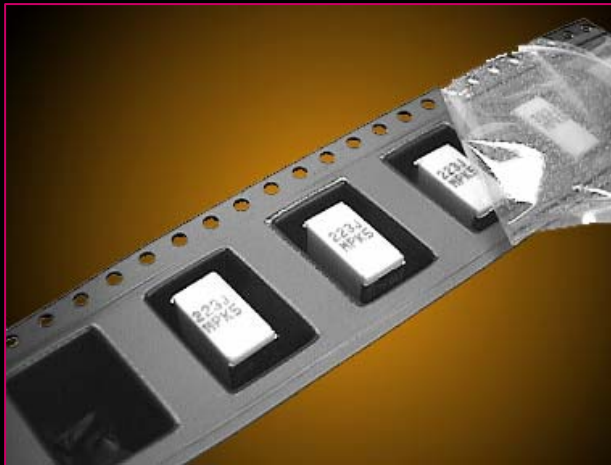
- For higher soldering temperatures.
- For better environmental stability.
- Higher C-values / voltages.

Naked:

- Low voltage / small C-values.
- Moderate soldering conditions.
- Few environmental concerns.
- Where small size is paramount.



Vertical mounting of encapsulated parts.

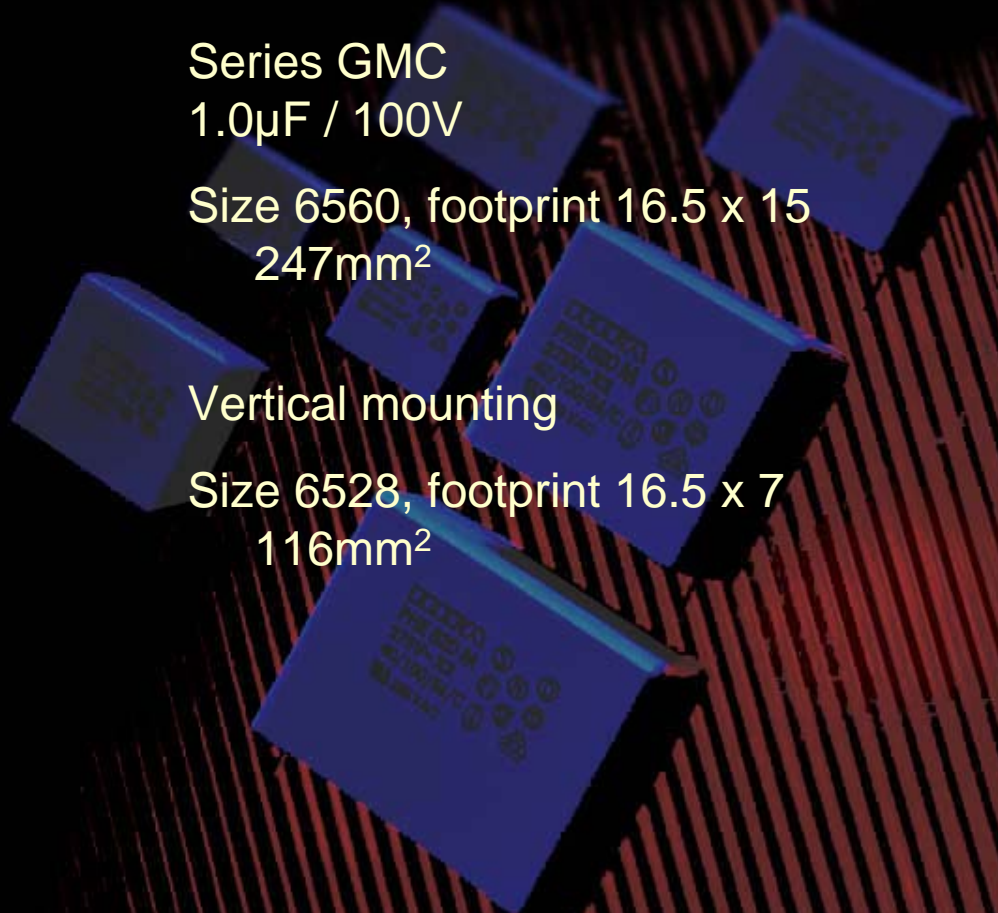


Series GMC
1.0 μ F / 100V

Size 6560, footprint 16.5 x 15
247mm²

Vertical mounting

Size 6528, footprint 16.5 x 7
116mm²



New products enhance our SMD offering.



- Series GPC for pulse applications.
dV/dt values up to 2200 V/ μ S.
- Series SPC – like GPC but better at high frequencies.
- Series SMP253, safety agency approved Y2 capacitor.



Key Selling Points

(Why Kemet SMD Film?)



- Broad product range:
 - Choose from multiple dielectrics.
 - Naked or encapsulated.
 - SMD pulse/AC capacitors GPC and SPC.
 - SMD Y capacitor SMP253.
- Superior solder withstand.
- Superior environmental protection.
- No thermal expansion stress problem.
- Vertical mounting option saves footprint.

